# Materials Declaration Form

<table>
<thead>
<tr>
<th>IPC</th>
<th>1752</th>
<th>Version</th>
</tr>
</thead>
<tbody>
<tr>
<td>Form Type</td>
<td>Distribute</td>
<td></td>
</tr>
<tr>
<td>Sectionals</td>
<td>Material Info</td>
<td>Manufacturing Info</td>
</tr>
<tr>
<td>Subsectionals</td>
<td>* : Required Field</td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Supplier Information</th>
</tr>
</thead>
<tbody>
<tr>
<td>Company Name *</td>
</tr>
<tr>
<td>Response Date *</td>
</tr>
<tr>
<td>Contact Name *</td>
</tr>
<tr>
<td>Authorized Representative *</td>
</tr>
<tr>
<td>Representative Title</td>
</tr>
<tr>
<td>Representative Phone *</td>
</tr>
<tr>
<td>Representative Email *</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Supplier Comment</th>
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</table>

## Uncertainty Statement

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**Supplier Acceptance ***: true

**Legal Declaration ***: Standard

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<table>
<thead>
<tr>
<th>Product</th>
<th></th>
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</thead>
<tbody>
<tr>
<td>Mfr Item Number</td>
<td>Mfr Item Name</td>
</tr>
<tr>
<td>STPS10H100CFP</td>
<td>HTU*Q99P025</td>
</tr>
<tr>
<td>Amount</td>
<td>UoM</td>
</tr>
<tr>
<td>1900.00</td>
<td>mg</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Manufacturing information</th>
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</thead>
<tbody>
<tr>
<td>J-STD-020 MSL Rating</td>
<td>Classification Temp</td>
</tr>
<tr>
<td>NAC</td>
<td>NAC</td>
</tr>
<tr>
<td>bulk Solder Termination</td>
<td>Terminal Plating</td>
</tr>
<tr>
<td>NAC</td>
<td>Tin (Sn), matte</td>
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</table>

<table>
<thead>
<tr>
<th>Package Designator</th>
<th>Size</th>
<th>Nbr of instances</th>
<th>Shape</th>
</tr>
</thead>
<tbody>
<tr>
<td>SIP</td>
<td>10.2-16.15-4.5</td>
<td>3</td>
<td>THROUGH HOLE</td>
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</tbody>
</table>

Comment: TO 220 ISOL FULL PACK 0.5 AB
### QueryList: ROHS directive 2011/65/EU _ July 2011

<table>
<thead>
<tr>
<th>Query</th>
<th>Response</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 - Product(s) meets EU RoHS requirement without any exemptions</td>
<td>false</td>
</tr>
<tr>
<td>2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)</td>
<td>false</td>
</tr>
<tr>
<td>3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)</td>
<td>true</td>
</tr>
<tr>
<td>4 - Product(s) does not meet EU RoHS requirements and is not under exemptions</td>
<td>false</td>
</tr>
<tr>
<td>5 - Product(s) is obsolete, no information is available</td>
<td>false</td>
</tr>
<tr>
<td>6 - Product(s) is unknown, no information is available</td>
<td>false</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Exemption Id.</th>
<th>Description</th>
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<tbody>
<tr>
<td>7a</td>
<td>Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead)</td>
</tr>
</tbody>
</table>

### QueryList: REACH-17th December 2015

<table>
<thead>
<tr>
<th>Query</th>
<th>Response</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH</td>
<td>true</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>CategoryLevel_Name</th>
<th>CategoryLevel_Threshold</th>
<th>amount in product (mg)</th>
<th>Application</th>
<th>ppm in product</th>
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</thead>
<tbody>
<tr>
<td>Homogeneous Material</td>
<td>Material Group</td>
<td>UoM</td>
<td>Level</td>
<td>Substance Category</td>
</tr>
<tr>
<td>----------------------</td>
<td>----------------</td>
<td>-----</td>
<td>-------</td>
<td>------------------</td>
</tr>
<tr>
<td>Die</td>
<td>Other inorganic materials</td>
<td>mg</td>
<td>supplier</td>
<td>Alle</td>
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</table>

**Material Composition Declaration**: HTUI*Q99P025

**Mfr Item Name**: 1900.0000 6000000.0 1000000.0